How to Write a Quality Technical Paper and Where to Publish within IEEE

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About the Keynote Speaker

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Professor of the Computer Science Department with the Center for Research and Advanced Studies of the National Polytechnic Institute, Mexico City, Mexico.



- IEEE Fellow for contributions to multi-objective optimization and constrainthandling techniques. Being a Fellow is the highest distinction granted by the IEEE to its members. No more than one tenth of the 1% of its voting members can obtain this distinction each year.
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- Currently Associate Editor for the following IEEE journals: IEEE Transactions on Evolutionary Computation
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Structure



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An effective title should...
Answer the reader's question: *"Is this article relevant to me?"*Grab the reader's attention
Describe the content of a paper

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Paper Structure Good vs. Bad Title

A Human Expert-based Approach to Electrical Peak Demand Management

VS

A better approach of managing environmental and energy sustainability via a study of different methods of electric load forecasting



Paper Structure Abstract





Paper Structure Good vs. Bad Abstract

The objective of this paper was to propose a human expert-based approach to electrical peak demand management. The proposed approach helped to allocate demand curtailments (MW) among distribution substations (DS) or feeders in an electric utility service area based on requirements of the central load dispatch center. Demand curtailment allocation was quantified taking into account demand response (DR) potential and load curtailment priority of each DS, which can be determined using DS loading level, capacity of each DS, customer types (residential/commercial) and load categories (deployable, interruptible or critical). Analytic Hierarchy Process (AHP) was used to model a complex decision-making process according to both expert inputs and objective parameters. Simulation case studies were conducted to demonstrate how the proposed approach can be implemented to perform DR using real-world data from an electric utility. Simulation results demonstrated that the proposed approach is capable of achieving realistic demand curtailment allocations among different DSs to meet the peak load reduction requirements at the utility level.

Vs



This paper presents and assesses a framework for an engineering capstone design program. We explain how student preparation, project selection, and instructor mentorship are the three key elements that must be addressed before the capstone experience is ready for the students. Next, we describe a way to administer and execute the capstone design experience including design workshops and lead engineers. We describe the importance in assessing the capstone design experience and report recent assessment results of our framework. We comment specifically on what students thought were the most important aspects of their experience in engineering capstone design and provide quantitative insight into what parts of the framework are most important.

First person, present tense No actual results, only describes the organization of the paper

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- A description of the problem you researched
- It should move step by step through:



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Paper Structure Methodology

- Problem formulation and the processes used to solve the problem, prove or disprove the hypothesis
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- Why your research offers a new solution
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ITMENEZ-MUNOI e' el : LET RETRIEVAL METHODO FROM LANDSAT-S THERMAL IMPRARED SEMSOR DATA

the SC algorithm over the whole range of ω values increase to 3-4 K, assept for the TiGR₄₁₁ doubtant, with m RMSE of 2 K. This last result is explained by the ω distribution, which is biased toward low values of ω in this doubtant. When only sumophanic profiles with ω values lower than $3 \ g \ cm^{-2}$ are saleted, the SC algorithm provides RMSE around 1.5 K, with almost equal values of this rand standard deviation, around 1 K in both cases (with a negative bias, these the SC understimizes the LST). In contrast, when only ω values higher than $3 \ g \ cm^{-2}$ are considered, the SC algorithm for calculate the homospheric functions of the SC algorithm diresulty from (3) rather than approximing them by a polynomial frapersonia agives by (4).

V. DISCUSSION AND CONCLUSION

The two Londoot-3 TIR bands allow the intercomparison of two LST retrieval methods based on different physical assumptions, such as the SC (only one TIR band required)

Discussion

titime (two TIR heads required). Diese investion to transfar equation, which can be considered benchm, is assumed to be a "ground-truth" andihor that the information about the and the problem of the structure of the structure of the structure of the previous SC subped for London't and London't TM searces, as EIM- searce on board the London't Thirty patients

[9], and it could be used to generate consistent LST products from the historical Landant flow using a single algorithm. An advantage of the SC algorithm is that, quart from surface emisnivity, only water vapor contant is required as input. However, it is expected that errors on LST becomes uncompetible for high water vapor contents $(x_{2,r} > 3 g \cdot cm^{-3})$. This problem can be parily solved by computing the atmospheric functions discolufrom τ , L_{τ} , and L_{τ} values (see (3)), or shot by including air temperatures as imput [15]. A main advantage of the SW algorithm is the it performs well over global conditions and, thus, a wide range of water vapor values; and dust it only requires water vapor as input (apart from surface emissivity relates water vapor as input (apart from surface semissivity and the two TIR bandt). However, the SW algorithm can be only copied to the new Landan-6 TIRS data, since previous TMETM senters call Figure TIRS data, since previous

The LST algorithmic presented in this latter wave started with simulated data sets obtained for a variety of global atmospheric conditions and surface emissivities. The setuble showed MMSE values of typically less than 1.5 K, although for the SC algorithm, this accuracy is only achieved from where below 3 g $-cm^{-2}$. Algorithm tasting also showed that the SW errors are lower than the SC error for increasing water vapor, and view wave, or desconstrated in the simulation study presented in Sobriso and Jimsteen-Mottoe [18]. Although an extensive validation execution from in the measurement in required to makes the performance of the two LST algorithms, is a wall as the performance of the two LST algorithm the sume mothemation it tracture give confidence in the algorithm accuracies estimated there.



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Paper Structure Conclusion

- Explain what the research has achieved
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Properly
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We then have
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(P_t^{s,+} + P_t^{s,-})^2 = (P_t^{s,+} - P_t^{s,-})^2 + 4P_t^{s,+}P_t^{s,-}
                                   <(\hat{P}_{r}^{a,+}-\hat{P}_{r}^{a,-})^{2}+4\hat{P}_{r}^{a,+}\hat{P}_{r}^{a,+}
                                   -(\hat{P}_{i}^{a,+} + \hat{P}_{i}^{a,-})^{2},
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Since $P_t^{b,+} - P_t^{b,-} = \hat{P}_t^{b,+} - \hat{P}_t^{b,-}$, we then have $P_t^{b,+} < P_t^{b,+}$. and $P_t^{s,-} < P_t^{s,-}$. Because the operational cost is an increasing function of $\{P_t^{s,+}, P_t^{s,-}\}$, we obtain that

> $c_{u/m}(P_t^{s,+}, P_t^{s,-}) < c_{u/m}(\dot{P}_t^{s,+}, \dot{P}_t^{s,-}).$ (33)

Therefore the optimal pair $\{P_t^{k,+},P_t^{k,-}\}$ must satisfy that $P_t^{k,+}P_t^{k,-} = 0$, i.e., only one of $P_t^{k,+},P_t^{k,-}$ can be non-zero.

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